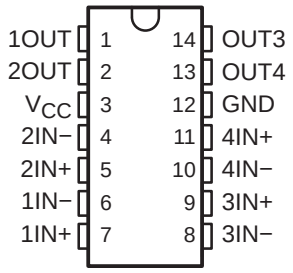
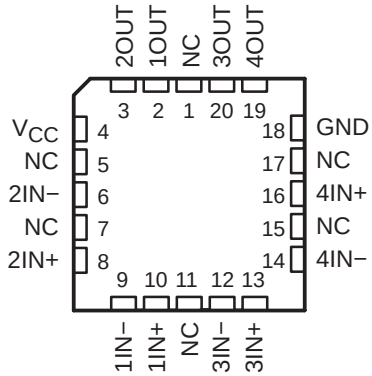
- **Single Supply or Dual Supplies**
- **Wide Range of Supply Voltage:**
  Max Rating . . . 2 V to 36 V
  Tested . . . 2 V to 30 V Non-V Devices
  Tested . . . 2 V to 32 V V-Suffix Devices
- **Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ**
- **Low Input Bias Current . . . 25 nA Typ**
- **Low Input Offset Current . . . 3 nA Typ (LM139)**
- **Low Input Offset Voltage . . . 2 mV Typ**
- **Common-Mode Input Voltage Range Includes Ground**
- **Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ±36 V**
- **Low Output Saturation Voltage**
- **Output Compatible With TTL, MOS, and CMOS**
- **For Single Version in SOT23-5, See TL331**

LM139, LM139A . . . D, J, OR W PACKAGE
LM239 . . . D, N, OR PW PACKAGE
LM239A . . . D PACKAGE
LM339, LM339A . . . D, DB, N, NS, OR PW PACKAGE
LM2901 . . . D, N, NS, OR PW PACKAGE
(TOP VIEW)



LM139, LM139A . . . FK PACKAGE
(TOP VIEW)



NC − No internal connection

description/ordering information

These devices consist of four independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible as long as the difference between the two supplies is 2 V to 36 V, and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

The LM139 and LM139A are characterized for operation over the full military temperature range of −55°C to 125°C. The LM239 and LM239A are characterized for operation from −25°C to 125°C. The LM339 and LM339A are characterized for operation from 0°C to 70°C. The LM2901 is characterized for operation from −40°C to 125°C.

description/ordering information (continued)

ORDERING INFORMATION

T_A	V_{IO}max AT 25°C	MAX V_{CC}	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	5 mV	30 V	PDIP (N)	Tube of 25	LM339N	LM339N
			SOIC (D)	Tube of 50	LM339D	LM339
				Reel of 2500	LM339DR	
			SOP (NS)	Reel of 2000	LM339NSR	LM339
			SSOP (DB)	Reel of 2000	LM339DBR	LM339
			TSSOP (PW)	Tube of 90	LM339PW	L339
				Reel of 2000	LM339PWR	
	2 mV	30 V	PDIP (N)	Tube of 25	LM339AN	LM339AN
			SOIC (D)	Tube of 50	LM339AD	LM339A
				Reel of 2500	LM339ADR	
			SOP (NS)	Reel of 2000	LM339ANSR	LM339A
			SSOP (DB)	Reel of 2000	LM339ADBR	L339A
			TSSOP (PW)	Tube of 90	LM339APW	L339A
				Reel of 2000	LM339APWR	
−25°C to 85°C	5 mV	30 V	PDIP (N)	Tube of 25	LM239N	LM239N
			SOIC (D)	Tube of 50	LM239D	LM239
				Reel of 2500	LM239DR	
			TSSOP (PW)	Tube of 90	LM239PW	L239
				Reel of 2000	LM239PWR	
	2 mV	30 V	SOIC (D)	Tube of 50	LM239AD	LM239A
				Reel of 2500	LM239ADR	
−40°C to 125°C	7 mV	30 V	PDIP (N)	Tube of 25	LM2901N	LM2901N
			SOIC (D)	Tube of 50	LM2901D	LM2901
				Reel of 2500	LM2901DR	
			SOP (NS)	Reel of 2000	LM2901NSR	LM2901
			TSSOP (PW)	Tube of 90	LM2901PW	L2901
				Reel of 2000	LM2901PWR	
	7 mV	32 V	SOIC (D)	Reel of 2500	LM2901VQDR	L2901V
			TSSOP (PW)	Reel of 2000	LM2901VQPWR	L2901V
	2 mV	32 V	SOIC (D)	Reel of 2500	LM2901AVQDR	L2901AV
			TSSOP (PW)	Reel of 2000	LM2901AVQPWR	L2901AV

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

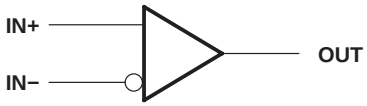
description/ordering information (continued)

ORDERING INFORMATION

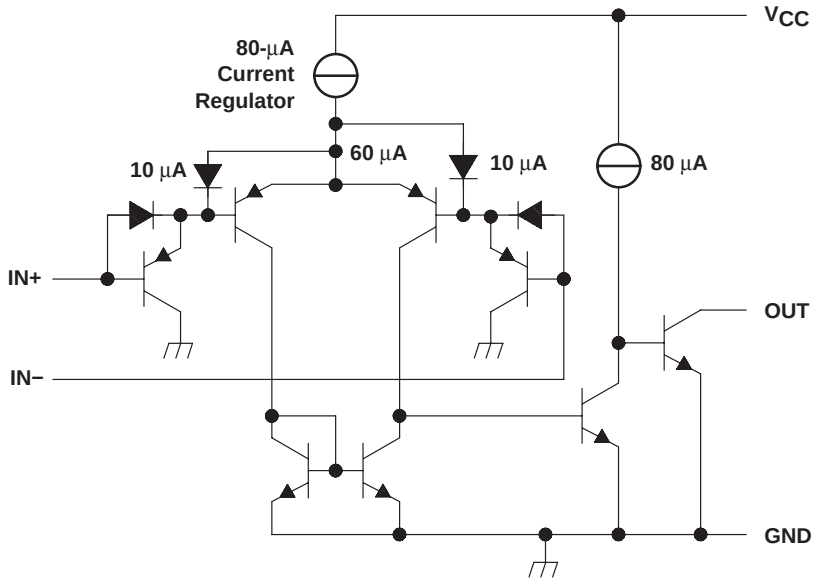
T_A	V_{IO}max AT 25°C	MAX V_{CC}	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
−55°C to 125°C	5 mV	30 V	CFP (W)	Tube of 25	LM139W	LM139W
			CDIP (J)	Tube of 25	LM139J	LM139J
			LCCC (FK)	Tube of 55	LM139FK	LM139FK
			SOIC (D)	Tube of 50	LM139D	LM139D
				Reel of 2500	LM139DR	
	2 mV	30 V	CFP (W)	Tube of 25	LM139AW	LM139AW
			CDIP (J)	Tube of 25	LM139AJ	LM139AJ
			LCCC (FK)	Tube of 55	LM139AFK	LM139AFK
			SOIC (D)	Tube of 50	LM139AD	LM139AD
				Reel of 2500	LM139ADR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol (each comparator)



schematic (each comparator)



All current values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)		36 V
Differential input voltage, V_{ID} (see Note 2)		±36 V
Input voltage range, V_I (either input)		−0.3 V to 36 V
Output voltage, V_O		36 V
Output current, I_O		20 mA
Duration of output short circuit to ground (see Note 3)		Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5):	D package	86°C/W
	DB package	96°C/W
	N package	80°C/W
	NS package	76°C/W
	PW package	113°C/W
Package thermal impedance, θ_{JC} (see Notes 6 and 7):	FK package	5.61°C/W
	J package	15.05°C/W
	W package	14.65°C/W
Operating virtual junction temperature, T_J		150°C
Case temperature for 60 seconds: FK package		260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package		300°C
Storage temperature range, T_{stg}		−65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES:
1. All voltage values, except differential voltages, are with respect to network ground.
2. Differential voltages are at IN+ with respect to IN−.
3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
4. Maximum power dissipation is a function of $T_J(max)$, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
5. The package thermal impedance is calculated in accordance with JESD 51-7.
6. Maximum power dissipation is a function of $T_J(max)$, θ_{JC}, and T_C. The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_J(max) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
7. The package thermal impedance is calculated in accordance with MIL-STD-883.

electrical characteristics at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		T_A‡	LM139			LM139A			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_{CC} = 5 V to 30 V, $V_{IC} = V_{ICR}$(min), V_O = 1.4 V		25°C		2	5		1	2	mV
				Full range			9			4	
I_{IO}	Input offset current	V_O = 1.4 V		25°C		3	25		3	25	nA
				Full range			100			100	
I_{IB}	Input bias current	V_O = 1.4 V		25°C		−25	−100		−25	−100	nA
				Full range			−300			−300	
V_{ICR}	Common-mode input-voltage range			25°C	0 to V_{CC}−1.5			0 to V_{CC}−1.5			V
				Full range	0 to V_{CC}−2			0 to V_{CC}−2			
A_{VD}	Large-signal differential-voltage amplification	$V_{CC}\pm$ = ±7.5 V, V_O = −5 V to 5 V		25°C		200		50	200		V/mV
I_{OH}	High-level output current	V_{ID} = 1 V	V_{OH} = 5 V	25°C		0.1			0.1		nA
			V_{OH} = 30 V	Full range			1			1	µA
V_{OL}	Low-level output voltage	V_{ID} = −1 V,	I_{OL} = 4 mA	25°C		150	400		150	400	mV
				Full range			700			700	
I_{OL}	Low-level output current	V_{ID} = −1 V,	V_{OL} = 1.5 V	25°C	6	16		6	16		mA
I_{CC}	Supply current (four comparators)	V_O = 2.5 V,	No load	25°C		0.8	2		0.8	2	mA

† All characteristics are measured with zero common-mode input voltage, unless otherwise specified.
‡ Full range (MIN to MAX) for LM139 and LM139A is −55°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CONDITIONS		LM139 LM139A			UNIT
			MIN	TYP	MAX	
Response time	R_L connected to 5 V through 5.1 kΩ, C_L = 15 pF§, See Note 8	100-mV input step with 5-mV overdrive		1.3		µs
		TTL-level input step		0.3		

§ C_L includes probe and jig capacitance.
NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

electrical characteristics at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		T_A‡	LM239, LM339			LM239A, LM339A			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	Input offset voltage	V_{CC} = 5 V to 30 V, $V_{IC} = V_{ICR}$(min), V_O = 1.4 V		25°C		2	5		1	3	mV
				Full range			9			4	
I_{IO}	Input offset current	V_O = 1.4 V		25°C		5	50		5	50	nA
				Full range			150			150	
I_{IB}	Input bias current	V_O = 1.4 V		25°C		−25	−250		−25	−250	nA
				Full range			−400			−400	
V_{ICR}	Common-mode input-voltage range			25°C	0 to V_{CC}−1.5			0 to V_{CC}−1.5			V
				Full range	0 to V_{CC}−2			0 to V_{CC}−2			
A_{VD}	Large-signal differential-voltage amplification	V_{CC} = 15 V, V_O = 1.4 V to 11.4 V, $R_L \geq 15\ k\Omega$ to V_{CC}		25°C	50	200		50	200		V/mV
I_{OH}	High-level output current	V_{ID} = 1 V	V_{OH} = 5 V	25°C		0.1	50		0.1	50	nA
			V_{OH} = 30 V	Full range			1			1	µA
V_{OL}	Low-level output voltage	V_{ID} = −1 V,	I_{OL} = 4 mA	25°C		150	400		150	400	mV
				Full range			700			700	
I_{OL}	Low-level output current	V_{ID} = −1 V,	V_{OL} = 1.5 V	25°C	6	16		6	16		mA
I_{CC}	Supply current (four comparators)	V_O = 2.5 V,	No load	25°C		0.8	2		0.8	2	mA

† All characteristics are measured with zero common-mode input voltage, unless otherwise specified.
‡ Full range (MIN to MAX) for LM239 and LM239A is −25°C to 85°C, for LM339 and LM339A is 0°C to 70°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CONDITIONS		LM239, LM239A, LM339, LM339A			UNIT
			MIN	TYP	MAX	
Response time	R_L connected to 5 V through 5.1 kΩ, C_L = 15 pF§, See Note 8	100-mV input step with 5-mV overdrive		1.3		µs
		TTL-level input step		0.3		

§ C_L includes probe and jig capacitance.
NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

electrical characteristics at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		T_A‡	LM2901			UNIT
					MIN	TYP	MAX	
V_{IO}	Input offset voltage	$V_{IC} = V_{ICR}$(min), V_O = 1.4 V	V_{CC} = 5 V to 30 V, (non-V devices)	25°C		2	7	mV
				Full range			15	
			V_{CC} = 5 V to 32 V, (V-suffix devices)	25°C		2	7	
				Full range			15	
I_{IO}	Input offset current	V_O = 1.4 V		25°C		5	50	nA
				Full range			200	
I_{IB}	Input bias current	V_O = 1.4 V		25°C		−25	−250	nA
				Full range			−500	
V_{ICR}	Common-mode input-voltage range			25°C	0 to V_{CC}−1.5			V
				Full range	0 to V_{CC}−2			
A_{VD}	Large-signal differential-voltage amplification	V_{CC} = 15 V, V_O = 1.4 V to 11.4 V, $R_L \geq 15\ k\Omega$ to V_{CC}		25°C	25	100		V/mV
I_{OH}	High-level output current	V_{ID} = 1 V	V_{OH} = 5 V	25°C		0.1	50	nA
			V_{OH} = 30 V (non-V devices)	Full range			1	µA
			V_{OH} = 32 V (V-suffix devices)	Full range			1	
V_{OL}	Low-level output voltage	V_{ID} = −1 V, I_{OL} = 4 mA	Non-V devices	25°C		150	500	mV
			V-suffix devices			150	400	
			All devices	Full range			700	
I_{OL}	Low-level output current	V_{ID} = −1 V,	V_{OL} = 1.5 V	25°C	6	16		mA
I_{CC}	Supply current (four comparators)	V_O = 2.5 V, No load	V_{CC} = 5 V	25°C		0.8	2	mA
			V_{CC} = 30 V (non-V devices)			1	2.5	
			V_{CC} = 32 V (V-suffix devices)			1	2.5	

† All characteristics are measured with zero common-mode input voltage, unless otherwise specified.
‡ Full range (MIN to MAX) for LM2901 is −40°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

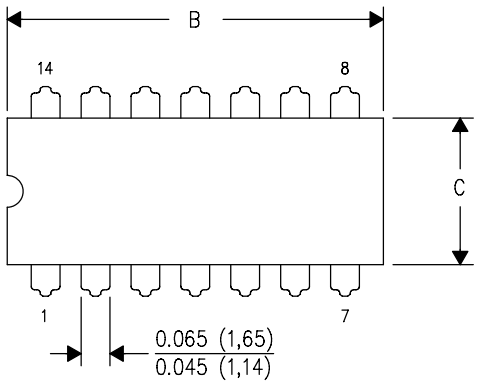
PARAMETER	TEST CONDITIONS		LM2901			UNIT
			MIN	TYP	MAX	
Response time	R_L connected to 5 V through 5.1 kΩ, C_L = 15 pF§, See Note 8	100-mV input step with 5-mV overdrive		1.3		µs
		TTL-level input step		0.3		

§ C_L includes probe and jig capacitance.
NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

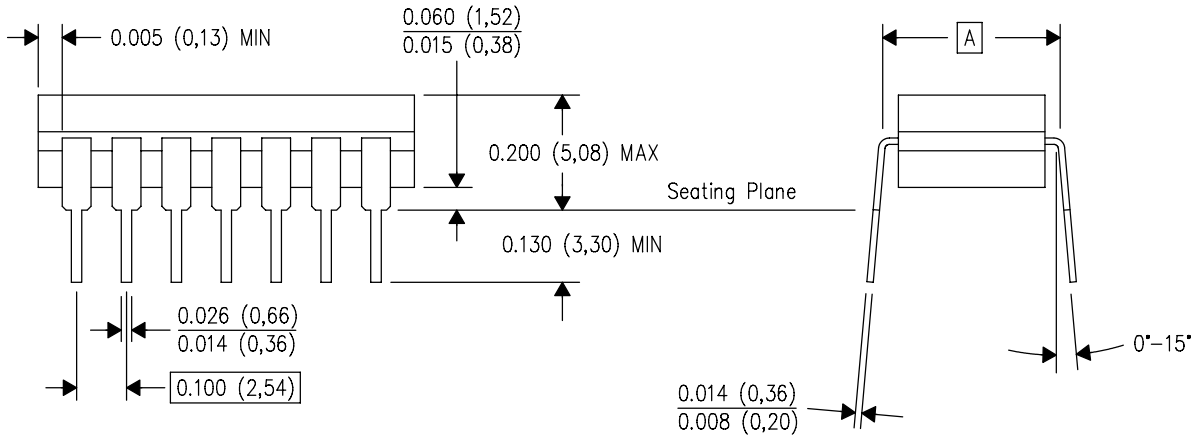
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

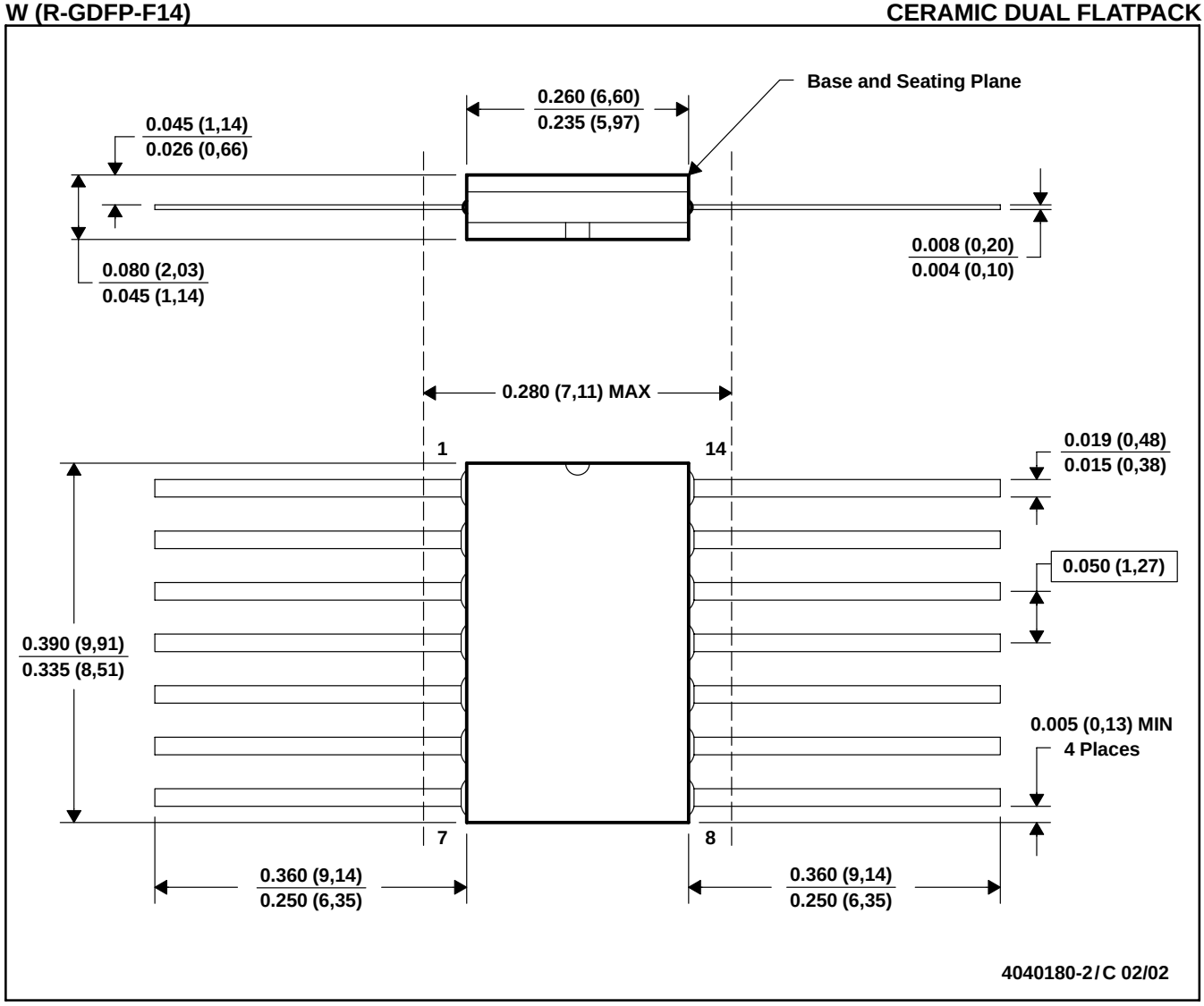


4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

MCFP002A – JANUARY 1995 – REVISED FEBRUARY 2002

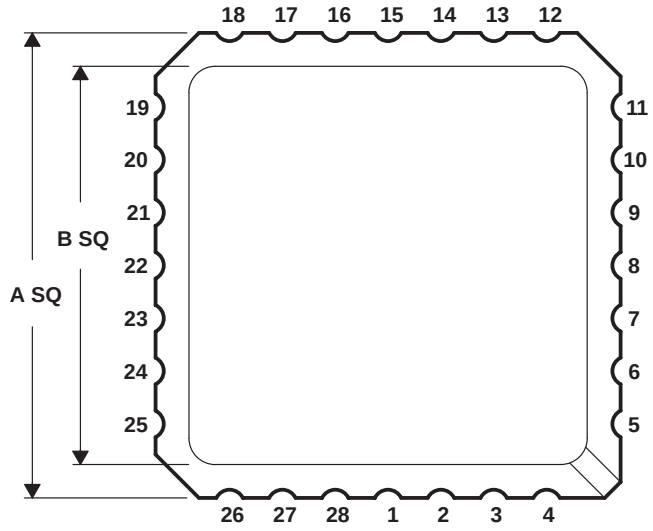
W (R-GDFP-F14) **CERAMIC DUAL FLATPACK**



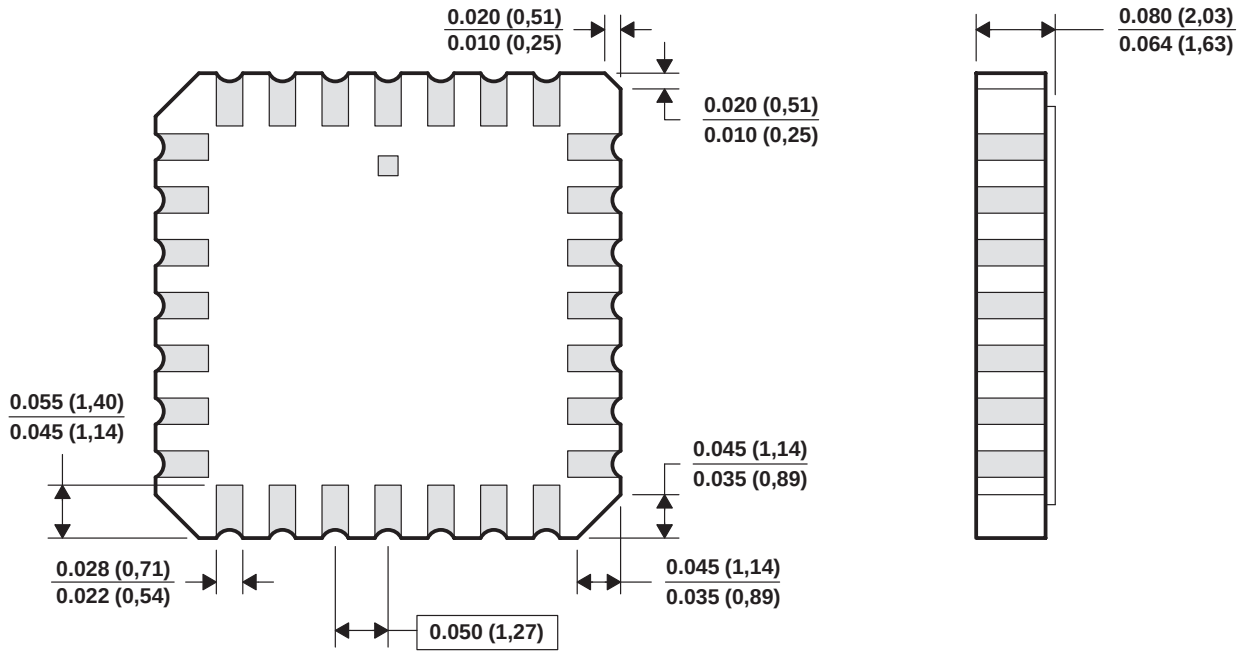
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N)** **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



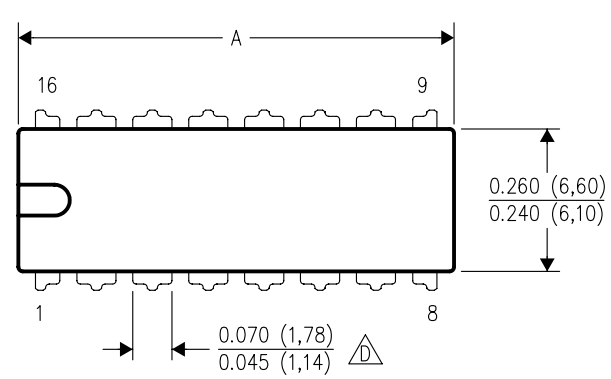
4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

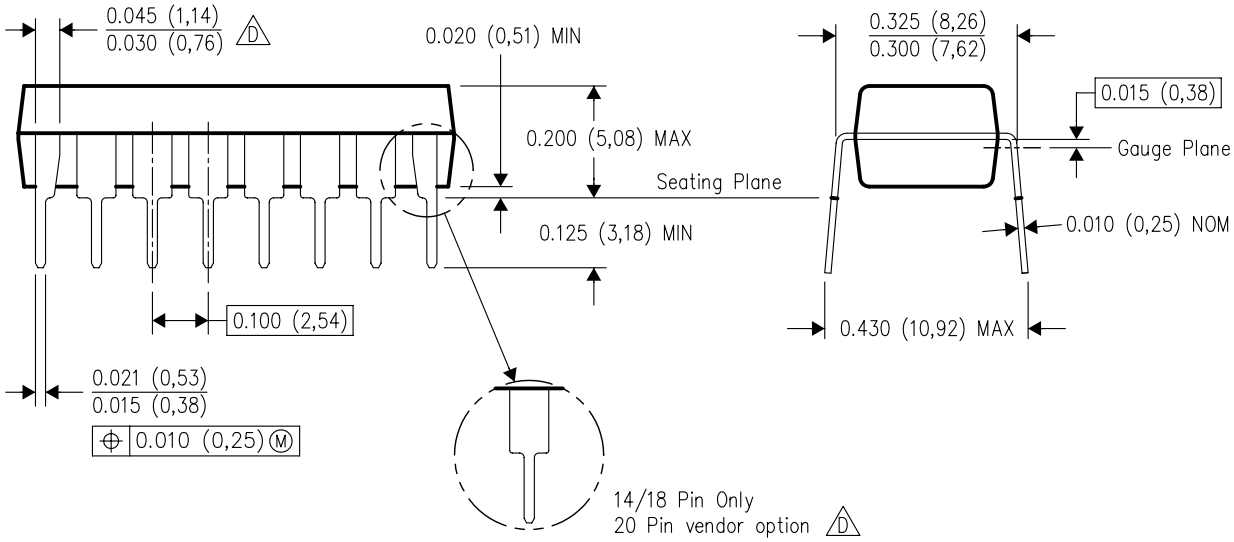
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

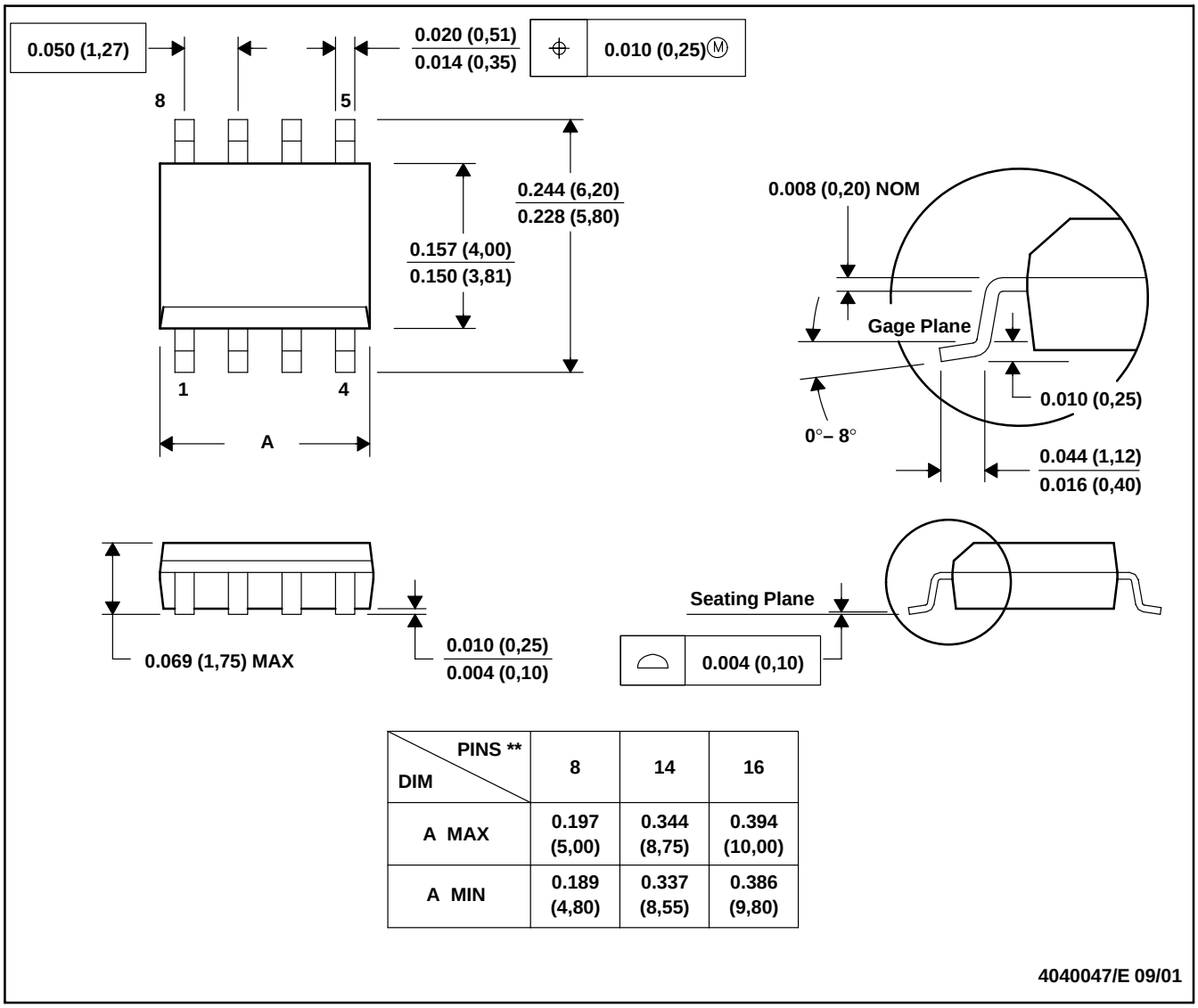
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

MSOI002B – JANUARY 1995 – REVISED SEPTEMBER 2001

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



DIM \ PINS **	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

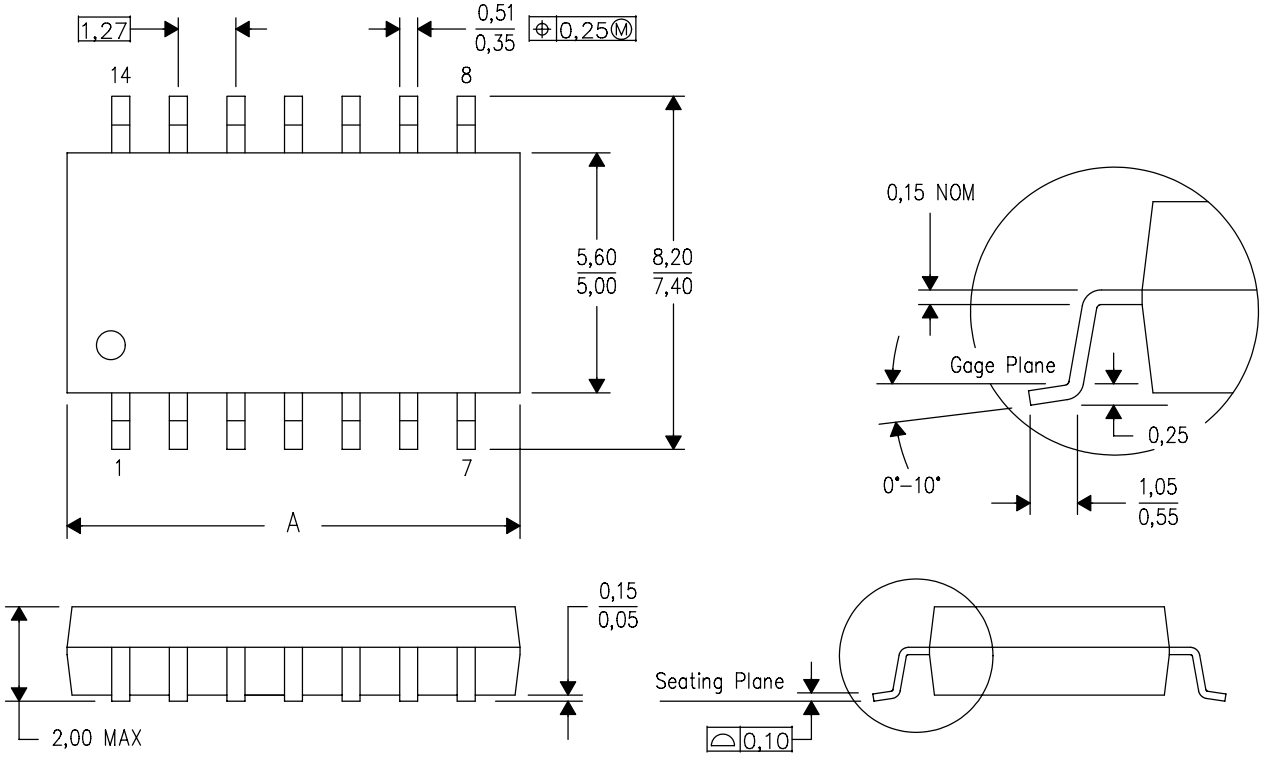
4040047/E 09/01

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

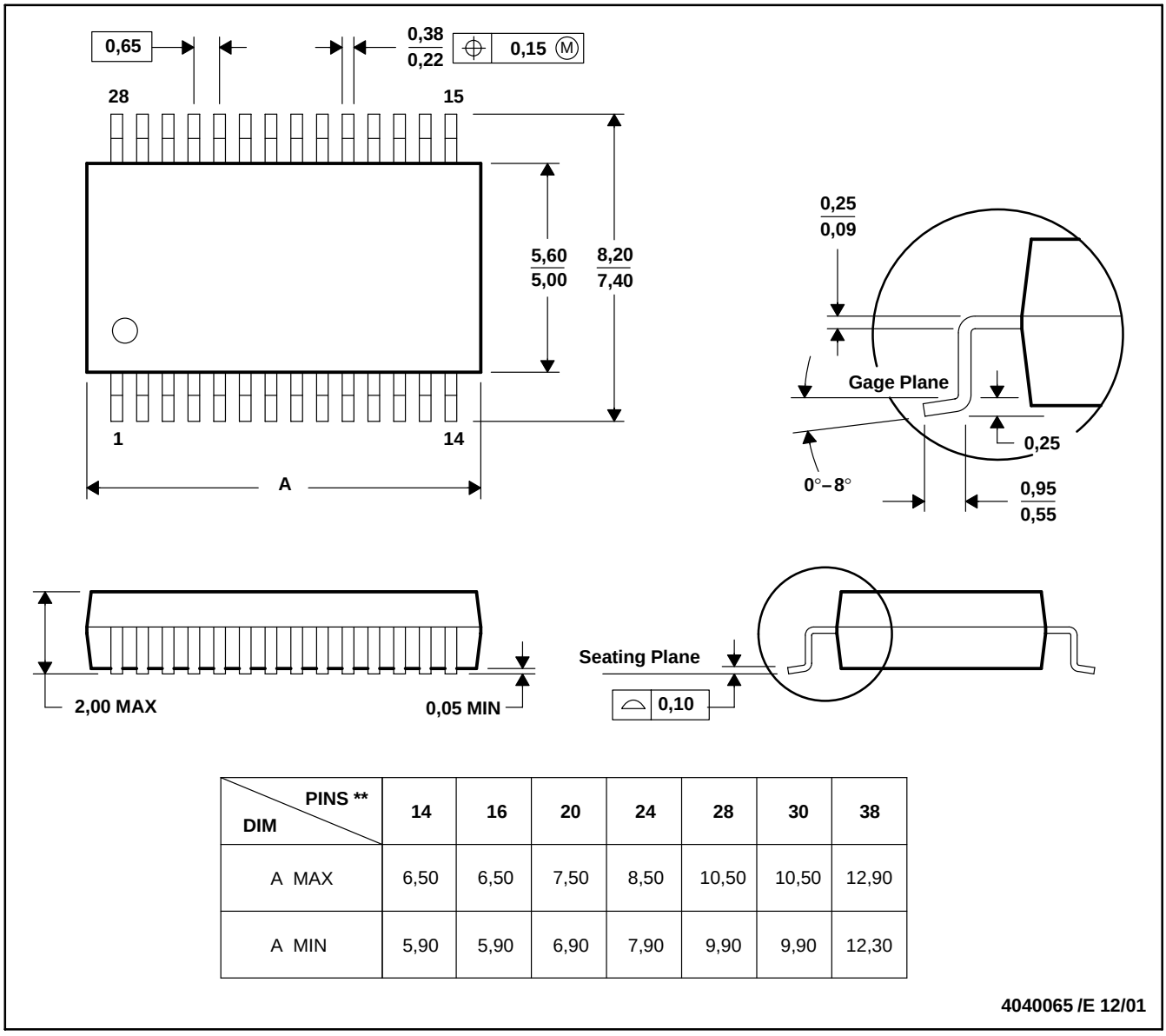
4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

MSSO002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)** **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN



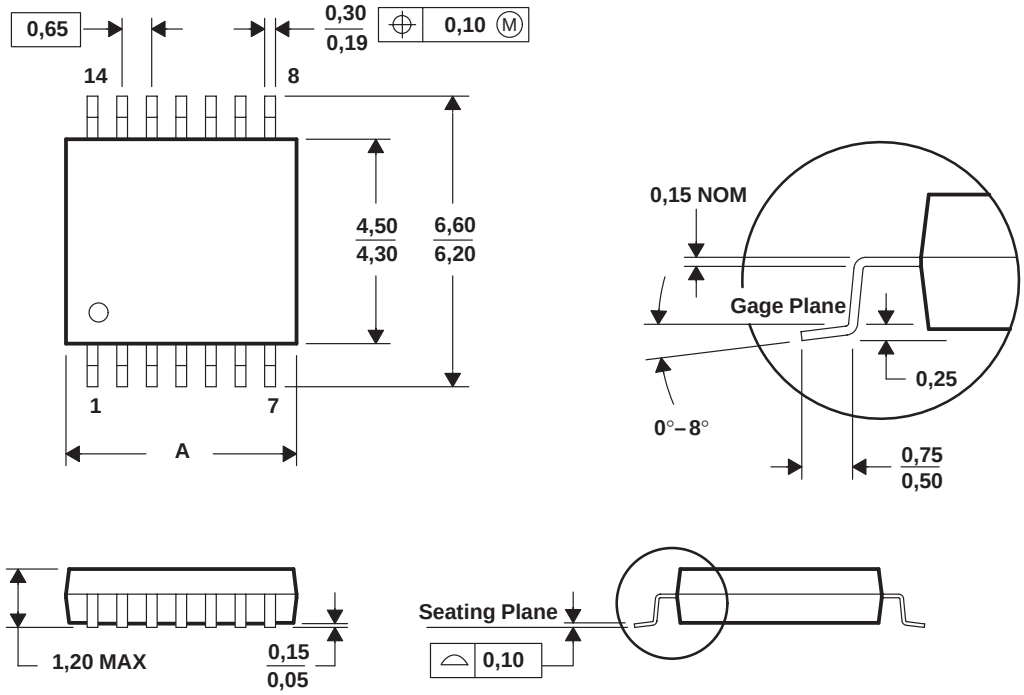
DIM \ PINS **	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

PW (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



DIM \ PINS **	8	14	16	20	24	28
A MAX	3,10	5,10	5,10	6,60	7,90	9,80
A MIN	2,90	4,90	4,90	6,40	7,70	9,60

4040064/F 01/97

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265